Signal Processing and Imaging with Ultrasonic Guided Waves: Goals, Challenges and Recent Progress

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Abstract

Ultrasonic guided waves have the potential for both rapid inspection and in situ monitoring of plate-like structures, and effective signal processing and imaging algorithms are essential to achieve necessary performance. Although guided waves can propagate long distances and still remain sensitive to damage, their dispersive nature and sensitivity to varying environmental and operational conditions offer significant challenges. This paper addresses two guided wave applications that have recently been the subject of significant research. The first is acquisition and analysis of full or partial guided wavefield data such as can be obtained by either a scanning laser vibrometer or a scanned air-coupled transducer. This application is motivated by the need for a rapid alternative to traditional bulk wave inspections that does not require extensive teardown or liquid couplants. The second is in situ monitoring using a spatially distributed array of simple piezoelectric transducers. This application is motivated by the need for long term monitoring of critical structures to both lower maintenance costs and prevent catastrophic failures. Recent results are presented from current and past projects of the QUEST Laboratory at Georgia Tech.

Keywords: Lamb waves, wavefield imaging, sparse arrays, adaptive imaging, damage characterization

1. Introduction

Ultrasonic guided waves, which are formed by the interaction of shear and longitudinal bulk waves with structural boundaries, can travel long distances while maintaining sufficient amplitude for damage detection. Guided waves in pipes have been successfully deployed for long distance detection of damage, enabling very fast screening of piping for damage without expensive disassembly [1,2]. One of the reasons for this success is that a pipe supports a wave mode traveling in a single direction (i.e., axially along the pipe). Such a wave is reflected from damage, and if the pipe geometry is simple, signal interpretation can be straightforward. In contrast, guided waves in plate-like structures are inherently two dimensional. These waves can also travel long distances, but signals are almost always very complicated for even simple structures because of the combined effects of multiple modes, multiple propagation directions, reflections from boundaries, and scattering from structural features [3]. This signal complexity is one of the major impediments to implementation of guided wave methods for nondestructive evaluation (NDE).

Several strategies have been developed in an attempt to overcome signal complexity issues and enable guided wave NDE in plates. One of these, called wavefield imaging, is to record received signals over a dense two dimensional grid using a single transducer source. Another strategy is that of baseline subtraction whereby baseline data are recorded from the undamaged structure and are subsequently subtracted from current signals of interest. This paper reviews methods and presents recent results based upon these two strategies.
2. Wavefield Imaging

The term “wavefield imaging” refers to acquiring full acoustic wavefield data over an area of the exposed part surface for a stationary source and multiple receiver locations. Implementation is typically via a scanned laser vibrometer (SLV) or a scanned air-coupled ultrasonic transducer (SAUT). Results shown here are wavefield data that were acquired from an aluminum plate with various structural discontinuities and artificial defects using an SAUT on a scanning stage. Wave sources were piezoelectric transducers permanently mounted on the specimen that were elements of a permanently attached sparse array. As shown in Figure 1, wavefield images clearly show details of guided waves as they propagate outward from the source, reflect from specimen boundaries, and scatter from discontinuities within the structure. Distinct $S_0$ and $A_0$ Lamb incident waves are directly visible on these constant time snapshots of the captured wavefield. However, as can be seen in the figure, the waves propagating outward from the source and reflected from boundaries obscure the weaker scattered waves from holes (H1, H2 and H3) and a second transducer (T6).

![Wavefield Images](image)

**FIGURE 1.** Acoustic wavefield images at propagation times of 30, 50 and 70 μs for transmitting on the transducer at (X=150 mm, Y=420 mm). Hole and transducer locations are shown on the 30 μs images, and scattering from these locations is observable on the later time images.

To facilitate analysis of the weaker scattered waves, source waves are removed from the wavefield data using both time and frequency domain methods [4,5]. Figure 2(a) shows a snapshot of a zoomed wavefield image that includes the incident wave and the wave scattered from a hole. Figure 2(b) shows the same image after the incident wave has been partially removed using an adaptive time domain subtraction method. Figure 2(c) shows the same image after the forward propagating wave has been removed by filtering in the $\omega-k_r$ domain. Both methods are effective at removing the incident wave, but also remove part of the scattered wave.

Results from the two methods are fused to obtain more complete information about the scattered wavefields. Figure 3 shows polar representations of the resulting scattered fields, first from a through hole, then the hole with a corner notch, and finally the hole with a through notch; the motivation is to simulate a growing crack. Plots are shown for source waves incident on the notch from two directions, one toward the side of the notch (transducer T1, top row) and the other toward the end of the notch (transducer T6, bottom row). The directional characteristics of the scatterer with respect to the source wave direction are evident along with the varying degrees of mode conversion as the symmetry changes. These
polar plots of the wavefields scattered from two incident wave orientations illustrate one method for experimentally obtaining quantitative flaw scattering characteristics without using damage-free baseline data. Additional details may be found in [6].

**FIGURE 2.** Analysis of waveforms in a region around Hole H3 where data were windowed in space over the zoomed region, in time from 0 to 50.6 μs, and in frequency from 0.2 MHz to 0.3 MHz. Snapshots of (a) the original wavefield, (b) after application of the time domain source removal method, and (c) after removing the out-going waves in the $\omega - k_r$ domain (applied to the original wavefield).

**FIGURE 3.** Scattered wavefields for hole H3 after combining results from the time domain and the $\omega - k_r$ domain methods to remove the incident wave. (a,b,c) Polar plots of $S_0$ and $A_0$ wave mode amplitudes for an incident wave direction of about 135° (approximately broadside to the notch). (d,e,f) Polar plots of $S_0$ and $A_0$ wave mode amplitudes for an incident wave direction of about 240° (approximately end-on to the notch).

### 3. Spatially Distributed Guided Wave Arrays

Spatially distributed arrays consist of individual piezoelectric transducers that are sparsely distributed over a region of interest. These types of arrays are being considered by a number of researchers for *in situ* NDE [7-9], also referred to as structural health monitoring (SHM).
The transducers, which are Lead Zirconate Titanate (PZT) discs, are permanently attached to the structure, and each one can act as either transmitter or receiver of guided elastic waves. The focus of the research activities in this general area has been to develop algorithms to enable detection, localization and characterization of structural damage based upon changes in recorded guided wave signals.

3.1 Guided wave imaging algorithms

Several imaging algorithms have been implemented for localizing damage in plate-like structures. Delay-and-sum (DAS) type algorithms such as were used in [7-9] can be effective for damage localization, but there are typically significant imaging artifacts. The MVDR (minimum variance distortionless response) adaptive algorithm, which is essentially delay-and-sum imaging with adaptive weights, can provide significant reduction of artifacts but requires knowledge of scattering characteristics [10,11]. Both of these algorithms are applied to the differenced, or residual, signals of a sparse array where baseline signals are subtracted from current signals. In essence, the signal changes are imaged. This subtraction is advantageous for a sparse array because, unlike a compact linear or circular array that relies upon backscattered waves, damage can be introduced in between array elements, and forward scattered signals cannot be separated from the direct arrivals by simple time windows.

Both DAS and MVDR imaging can be performed on either envelope-detected signals or raw (RF) waveforms. Figure 4 shows imaging results for a 6 mm drilled through-hole in an aluminum plate, and illustrates the improvement obtained when using MVDR compared to DAS. Imaging artifacts are suppressed by about 10 dB going from DAS to MVDR using envelope-detected signals, and there is a significant improvement in resolution when using phase information (i.e., imaging with the RF signals).

![Figure 4](image.png)

**FIGURE 4.** Images from experimental data for a 6 mm diameter through hole. (a) Delay-and-sum imaging with envelope data (10 dB color scale), (b) MVDR imaging with envelope data (20 dB color scale), and (c) MVDR imaging with RF data (20 dB color scale, note zoomed image around scatterer).

The open circles are the transducer locations, and the “+” is the location of the scatterer.

The significance of MVDR imaging is that it provides considerably improved results as compared to DAS imaging but with only a modest increase in the computational burden. For some cases, it is also less sensitive to signal-baseline mismatch caused by changes in operational or environmental conditions.

A new imaging algorithm, referred to here as Sparse Reconstruction (SR), was developed to utilize the *a priori* information that damage is sparse. The DAS and MVDR algorithms are not able to take this information into account, which leads to imaging artifacts. The idea of
the SR method is to select pixel values that provide a balance between explaining the data and being spatially sparse. This is accomplished here by using basis pursuit denoising [12] combined with a reasonable model of the guided wave propagation and scattering in the plate. Experimental results are shown in Figure 5 for one and two glued-on masses, which act as scatterers of guided waves and thus simulate damage. What is noteworthy is the complete lack of imaging artifacts away from the actual scattering sites, which is a direct result of the sparsity assumption.

![Figure 5](image)

**FIGURE 5.** SR images from experimental data for glued-on masses. (a) Single scatterer and (b) two scatterers. Images are shown on a 20 dB color scale; note zoomed views around scatterers. The white open circles are the transducer locations, and the red open circles are the locations of the scatterers.

Development of the SR method is significant because it illustrates how sparsity of damage can be effectively incorporated into imaging of scatterers. Experimental results shown here are limited, and future work needs to consider more realistic structures and damage. Additional information can be found in [13].

### 3.2 Damage characterization via guided wave imaging

The MVDR method requires that the expected scattering pattern be known (or estimated) prior to imaging, which can be problematic. On the other hand, if several types of scatterers are possible and their scattering patterns are known, MVDR has the advantage of being able to not only locate the scatterers but to characterize them. This idea is illustrated using data recorded from two different notches cut in an aluminum plate. A 15 mm long notch oriented at +45° was located in the lower left corner of the plate, and a similar notch oriented at -45° was located near the center of the plate. These notches, like cracks, are highly directional scatterers, and thus the two notches at the two different orientations scatter the guided waves quite differently.

Figure 6(a) shows the image generated of the +45° notch using the correct scattering pattern, whereas Figure 6(b) is the corresponding image on the same scale but created using the scattering pattern of a notch at 90°. Clearly the response is almost 20 dB lower in amplitude when the incorrect scattering pattern is used for imaging. Figure 6(c) shows the maximum response for both notches as a function of the orientation angle of the assumed scattering pattern. The peak locations of each curve agree well with the actual notch orientations. These results indicate that small scatterers can be characterized using a sparse array if their scattering characteristics are known and are sufficiently different. This idea is much different than traditional methods for characterizing scatterers using many measurements to directly
trace out the scattering pattern. Most importantly, it points the way to practical, in situ damage characterization using a very small number of transducers. Additional results can be found in [14].

![FIGURE 6](image)

**FIGURE 6.** Example of damage characterization via MVDR imaging. (a) MVDR image of a +45° notch using the correct scattering pattern. (b) MVDR image of the same notch but using an incorrect scattering pattern. (c) Maximum MVDR image amplitudes for both notches assuming scattering patterns corresponding to notch orientations of -90° to +90°.

### 3.3 Temperature effects

Variable operational and environmental conditions can adversely affect the performance of SHM systems by causing changes in guided wave signals that may either be mistaken for damage or mask damage. The three most common such conditions are temperature, stresses, and surface wetting; temperature is perhaps the most important because very small changes in temperature can significantly affect both detection and localization of damage.

The basic idea for most, if not all, temperature compensation methods is to (1) record baseline signals at a range of temperatures, (2) find the baseline signal that best matches the current signal of interest, and (3) adjust this signal to better match the current signal; refer to [9], [15] and [16] for details and examples. The first two steps are usually referred to as optimal baseline selection (OBS), and the last by baseline signal stretch (BSS) because signal stretching (with slight time shifts) is the usual method to achieve matching. This basic method was improved upon in several significant ways as summarized in Table 1:

| TABLE 1. Summary of changes to the OBS+BSS temperature compensation method. |
|---------------------------------|---------------------------------|
| **Original Method**             | **New Method**                  |
| 1. Stretch implemented in the frequency domain | 1. Stretch implemented in the time domain |
| 2. Stretch/shift algorithm:     | 2. Stretch/shift algorithm:      |
| a. Stretch computed from lags of short time cross correlation plotted at time window centers | a. Stretch computed from lags of short time cross correlation plotted at center of energy |
| b. Shift determined by cross correlation of entire stretched waveforms | b. Shift is y-intercept of lags vs. time |
| 3. Same baseline set selected for all pairs | 3. Individual baseline selected for each pair |
| 4. Single baseline used to construct matched signal | 4. Weighted average of two baselines used to construct matched signal |
These changes resulted in significant improvement in temperature compensation as measured by the detection margin – the dB difference in the residual signal before and after damage. Table 2 is a tabulation of improvement for five representative transducer pairs from a specific aluminum plate experiment. Note that the new method was able to achieve significantly better performance while using less data (smaller time window and lower sampling frequency). More details are found in [17].

<table>
<thead>
<tr>
<th>Transducer Pair</th>
<th>Detection Margin (dB)</th>
<th>Original Method</th>
<th>New Method</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>4000 μs, 25 MHz</td>
<td>1000 μs, 5 MHz</td>
<td>1000 μs, 5 MHz</td>
</tr>
<tr>
<td>1-3</td>
<td>4.30</td>
<td>1.30</td>
<td>7.06</td>
</tr>
<tr>
<td>2-3</td>
<td>3.10</td>
<td>2.48</td>
<td>6.83</td>
</tr>
<tr>
<td>3-4</td>
<td>4.80</td>
<td>1.82</td>
<td>6.16</td>
</tr>
<tr>
<td>3-5</td>
<td>1.02</td>
<td>-2.80</td>
<td>4.09</td>
</tr>
<tr>
<td>3-6</td>
<td>3.49</td>
<td>1.14</td>
<td>3.91</td>
</tr>
</tbody>
</table>

### 3.4 Loading effects

Applied loads cause similar effects as temperature because, like temperature, loads change both specimen dimensions and wave speeds. An important difference is that loads are generally anisotropic, which prohibits the BSS method from being used. To investigate loading effects, an aluminum plate specimen with a central hole was fatigued. Data were recorded as a function of load before the hole was drilled, after the hole was drilled, and at intervals thereafter as a function of fatigue life.

Figure 7 illustrates the effects of matched loads on a fatigue crack about 5 mm in length. Figures 7(a), (b) and (c) correspond to loads of 0, 57.5 and 115 MPa, respectively. It is clear that the main effect of the load is to open the crack. It is not detected at zero load, but as the load increases the crack opens and becomes increasingly evident.

**FIGURE 7.** Images constructed between pre-crack baseline signals and current signals recorded after growth of a ~5 mm fatigue crack. Both signals were recorded at the load indicated. (a) 0 MPa, (b) 57.5 MPa, and (c) 115 MPa. Images are shown on the same 10 dB color scale normalized to the overall peak value.
Figure 8 illustrates the effects of mismatched loads on the same fatigue crack. Signals from the crack were recorded at the maximum load of 115 MPa, whereas the baseline signals were recorded at variable but mismatched loads. Since the crack is fully opened for all three images, the main effect of the varying load of the baseline signals is to introduce imaging artifacts. For the images of Figure 8(a) and (b), the artifacts are as large as or larger than the crack, and thus the crack is not detectable. For Figure 8(c), where the mismatch is smaller, the image is only slightly degraded from that of Figure 7(c) and the crack is clearly detected.

**FIGURE 8.** Images constructed between pre-crack baseline signals and current signals recorded after growth of a ~5 mm fatigue crack. Current signals were recorded at the maximum load (115 MPa), and baseline signals were recorded at the load indicated. (a) 0 MPa, (b) 46 MPa, and (c) 92 MPa. Images are shown on separate 10 dB color scales with each normalized to its peak value.

These results illustrate the importance of both matched loads and loads sufficient to open cracks. They have also motivated development of load-differential imaging methods where baselines are recorded at one load and current signals at a slightly higher load but at the same damage state [18]. Figure 9 shows three sets of images generated by differential loads of 11.5 MPa. For the top row, there are no visible cracks, for the middle row there is a single 8 mm long crack, and for the bottom row there are two cracks of lengths 20 mm and 12 mm, one on each side of the hole. These images clearly show the cracks opening with load and did not use a damage-free baseline.

**FIGURE 9.** Load-differential images. Top row: no visible cracks. Middle row: single 8 mm long crack. Bottom row: two cracks of lengths 20 mm and 12 mm, one on each side of the hole. The differential loads increase from 0-10% to 90-100% from left to right, and the color scale is 30 dB.
4. Concluding Remarks

Results shown here illustrate both the challenges and the opportunities for using ultrasonic guided waves for both conventional and in situ NDE. Wavefield imaging has the potential to characterize defects by quantifying the full wavefield scattered from a flaw. Sparse, or spatially distributed, arrays have potential for in situ detection, localization and characterization of damage by monitoring changes in received signals. In general, the effects of variable operational and environmental conditions must be considered because the interaction of guided waves with boundaries makes them more sensitive to these variations than bulk waves.

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